

# PLATAMID® M 995 PELLETS

## Platamid® M 995 Pellets

Copolyamide Hot Melt Adhesive /Extrusion Applications

**Platamid® M 995 Pellets** is a standard thermoplastic copolyamide hot melt adhesive available in pellet form. This high melt viscosity grade is particularly suitable for manufacturing of films and masterbatches.

**Platamid® M 995 Pellets** offer very good adhesion to various polar substrates (thermoplastics, thermosets, metal, natural fibers, etc).

PROPERTIES	DRY / COND	UNIT	TEST STANDARD
<b>RHEOLOGICAL PROPERTIES</b>			
Melt Volume-Flow Rate	2 / *	cm <sup>3</sup> /10min	ISO 1133
Temperature	160 / *	°C	-
	320 / *	°F	-
Load	2.16 / *	kg	-
	4.76 / *	lb	-
<b>THERMAL PROPERTIES</b>			
Melting Temperature, 10°C/min	144 / *	°C	ISO 11357-1/-3

## AVAILABLE GRADES

This grade is available:

- dried (M 995 T)
- undried (M 995 F)

## PACKAGING

Platamid® M 995 T and Platamid® M 995 F are delivered in 25 kg sealed bags.

These grades are ready to be processed

## SHELF LIFE

Two years from the date of delivery. For any use above this limit, please refer to our technical services.

<b>PROCESSING</b>	
Film Extrusion	
<b>DELIVERY FORM</b>	
Pellets	
<b>SPECIAL CHARACTERISTICS</b>	
Adhesive	
<b>REGIONAL AVAILABILITY</b>	
North America, Europe, Asia Pacific, South and Central America, Near East/Africa	